Dual SPST Depletion Audio Switch with Negative Swing

FSA553
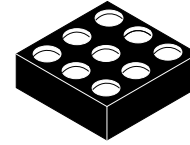
Description

   The FSA553 is a high−performance dual single−pole single−throw (SPST x 2) audio switch. The Depletion technology allows the device to conduct signals when there is no VCC available and to isolate signals when VCC is present. During signal conduction, the Depletion gate control allows the FSA553 to achieve excellent THD+N performance while consuming minimal power.

Features

- Dual SPST Depletion Switch
- Normally Closed when VCC < 0.2 V
- Switches Configurable through Select Pins
- V_{SW}: −1.5 V to +1.5 V
- R_{ON}: 0.4 Ω (Typical)
- R_{FLAT} < 0.01 Ω (Typical)
- THD+N: −104 dB (Typical)
- OIRR: −78 dB (Typical)
- This Device is Pb−Free and Halide Free

Table of Contents

- FSA553 Evaluation Board

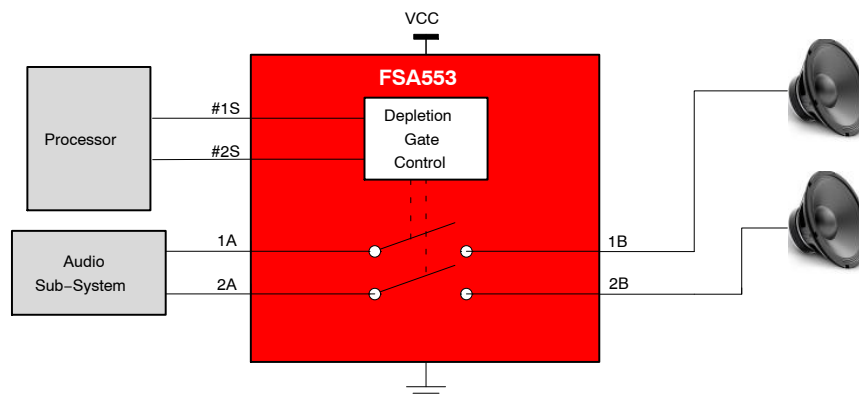## Applications

- Smart Phones
- Tablets, Ultra Books

MARKING DIAGRAM

NG&K
&.&2&Z

NG = Specific Device Code
&K = 2−Digits Lot Run Traceability Code
&. = Pin One Dot
&2 = 2−Digit Date Code
&Z = Assembly Plant Code

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping†
FSA553UCX	WLCSP9 (Pb−Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
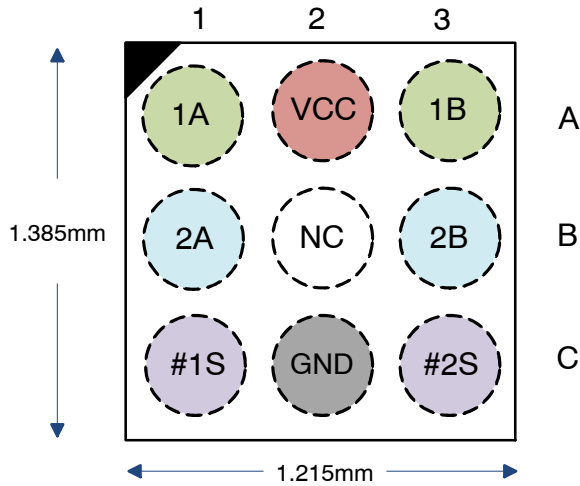
Block Diagram

Figure 1. Application Block Diagram

Pin Configuration

Figure 2. Top Through View
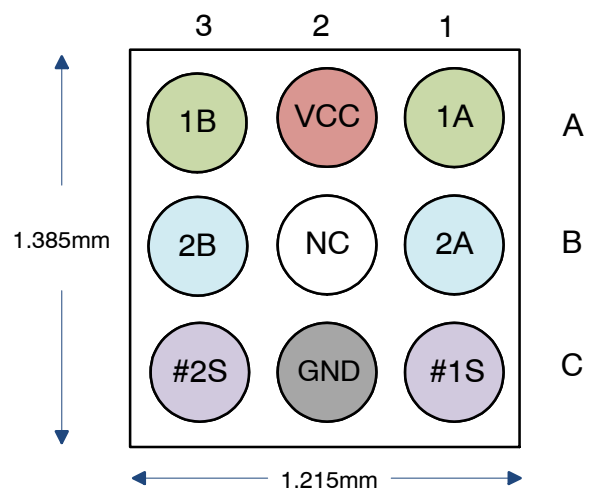
Figure 3. Bottom View

PIN DESCRIPTION

Pin #	Name	Type	Description
A1	1A	Depletion I/O	A−Port of Switch 1 (Normally Closed)
A3	1B	Depletion I/O	B−Port of Switch 1 (Normally Closed)
C1	#1S	Control	Select to Enable/Disable SW1 (Enable LOW)
A2	V_{CC}	Power Supply / Control	Power Supply Input
B2	NC	No Connect	Do Not Connect
C2	GND	Ground	Ground
B1	2A	Depletion I/O	A−Port of Switch 2 (Normally Closed)
B3	2B	Depletion I/O	B−Port of Switch 2 (Normally Closed)
C3	#2S	Control	Select to Enable/Disable SW2 (Enable LOW)

SWITCH TRUTH TABLE

V_{CC}	#1S	#2S	Switch 1	Switch 2
LOW	X	X	ON	ON
HIGH	HIGH	HIGH	OFF	OFF
HIGH	LOW	HIGH	ON	OFF
HIGH	HIGH	LOW	OFF	ON

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
V_{CC}	Supply/Control Voltage		−0.5	4.3	V
V_{CNTRL}	Select Input Voltage	#1S, #2S	−0.5	4.3	V
$V_{SW(ON)}$	DC Switch C Voltage (Switch Conducting)	1A, 1B, 2A, 2B	−2.0	2.0	V
$V_{SW(OFF)}$	DC Switch I/O Voltage (Switch Isolated)	1A, 1B, 2A, 2B	−2.0	2.0	V
I_{SW}	Switch I/O Current	V_{CC} = 0 V (Switch Conducting)		350	mA
I_{SWPEAK}	Peak Switch Current	Pulsed at 1 ms Duration, <10% Duty Cycle		500	mA
ESD	Human Body Model, ANSI/ESDA/JEDEC JS−001−2012	I/O Ports		7	kV
		All Other Pins		4	
	Charged Device Model, JEDEC: JESD22−C101			2	
	IEC 61000−4−2 System	Contact		8	
		Air Gap		15	
T_A	Absolute Maximum Operating Temperature		−40	+85	°C
θ_{JA}	Thermal Resistance, Junction−to−Ambient	2S2P JEDEC std. PCB		97	°C/W
T_{STG}	Storage Temperature		−65	+150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Max	Unit
$V_{CC(ON)}$	Supply Voltage with Depletion Switch Conducting (1A=1B; 2A=2B)		0	0.2	V
$V_{CC(OFF)}$	Supply Voltage with Depletion Switch Isolated (1A≠1B; 2A≠2B; #1S=#2S=HIGH)		1.5	3.0	V
$V_{SW(ON)}$	DC Switch I/O Input Voltage	Switch Conducting	−1.5	1.5	V
$V_{SW(OFF)}$	DC Switch I/O Input Voltage	Switch Isolated	−1.5	1.5	V
V_{CNTRL}	Select Input Voltage	#1S, #2S	0	3.0	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

FSA553

DC ELECTRICAL CHARACTERISTICS (Typical values are for $T_A = 25°C$ unless otherwise specified.)

Symbol	Parameter	Condition	V_{CC} (V)	$T_A = -40°C$ to $+85°C$ Min	Typ	Max	Unit
$V_{CC(HYS)}$	Supply Voltage Hysteresis				450		mV
I_{ON}	Switch ON Leakage Current	nA = −0.5 V, 0.5 V, 1.5 V, −1.5 V, nB = Float, #1S = #2S = Float	0		0.1		μA
I_{OFF}	Switch OFF Leakage Current	nA = −0.5 V, 0.5 V, 1.5 V, −1.5 V, nB = GND, #1S = #2S = V_{CC}	1.8		0.5		μA
I_{CCT}	Increase in I_{CC} for each Select Pin	#1S = V_{CC}, #2S = 1.2 V, #1S = 1.2 V, #2S = V_{CC}	3.0		7		μA
R_{ON}	Switch On Resistance	I_{SW} = 100 mA, V_{SW} = −1.5 V to +1.5 V	0		0.40	0.80	Ω
ΔR_{ON}	Switch On Resistance Difference, Channel to Channel	I_{SW} = 100 mA, V_{SW} = −1.5 V to +1.5 V	0		0.01		Ω
$R_{FLAT(ON)}$	On Resistance Flatness	I_{SW} = 100 mA, V_{SW} = −1.5 V to +1.5 V	0		0.01		Ω
R_{PD}	V_{CC} Pull−Down Resistance		<0.2		5.0		MΩ
R_{PU}	Select Pull−Up Resistance		<0.2		3.0		MΩ
I_{CC}	Quiescent Supply Current	Switch Isolated, #1S = #2S = V_{CC}	1.5 to 3.0		80		μA
		Switch On	0.2		0.5		
V_{IH}	Select Pin Input High Voltage		1.5 to 3.0	1.2			V
V_{IL}	Select Pin Input Low Voltage		1.5 to 3.0			0.55	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

AC ELECTRICAL CHARACTERISTICS (Typical values are for $T_A = 25°C$ unless otherwise specified.)

Symbol	Parameter	Condition		V_{CC} (V)	$T_A = -40°C$ to $+85°C$			Unit
					Min	Typ	Max	
t_{ON}	Turn–On Time V_{CC} to Output	$R_L = 32\ \Omega$, $C_L = 10$ pF, #nS = Float, Figure 4	$W_{SW} = 1.5$ V	$1.8 \to 0$		450		μs
			$W_{SW} = -1.5$ V	$1.8 \to 0$		350		
t_{OFF}	Turn–Off Time V_{CC} to Output	$R_L = 32\ \Omega$, $C_L = 10$ pF, #nS = Float, Figure 4	$W_{SW} = 1.5$ V	$0 \to 1.8$		250		μs
			$W_{SW} = -1.5$ V	$0 \to 1.8$		150		
t_{ONS}	Turn–On Time Select Pin	$R_L = 32\ \Omega$, $C_L = 10$ pF, #nS = $V_{CC} \to 0$, Figure 5	$W_{SW} = 1.5$ V	1.8		350		μs
			$W_{SW} = -1.5$ V	1.8		300		
t_{OFFS}	Turn–Off Time Select Pin	$R_L = 32\ \Omega$, $C_L = 10$ pF, #nS = $0 \to V_{CC}$, Figure 5	$W_{SW} = 1.5$ V	1.8		150		μs
			$W_{SW} = -1.5$ V	1.8		50		
BW	−3 dB Bandwidth	$V_{SW} = 600$ mV_{p-p}, $R_L = 50\ \Omega$; $C_L = 5$ pF,		0		200		MHz
THD+N	Total Harmonic Distortion + Noise	$V_{SW} = 1\ V_{RMS}$, $R_L = 32\ \Omega$, f = 1 kHz	Non A–weighted	0		−104		dB
			A–weighted			−107		dB
O_{IRR}	Port Off Isolation	$V_{SW} = 0.707\ V_{RMS}$, $R_L = 32\ \Omega$, f = 20 Hz to 100 kHz, Figure 6		1.8	−70	−82		dB
X_{TALK}	Cross Talk	$V_{SW} = 1\ V_{RMS}$, f = 100 kHz, $R_L = 32\ \Omega$		1.8		−75		dB
		$V_{SW} = 1\ V_{RMS}$, f = 20 kHz, $R_L = 32\ \Omega$				−100		
PSRR	Power Supply Rejection Ratio	Switch Isolating, $V_{Ripple} = V_{CC} + 300$ mV_{p-p}, $R_L = 32\ \Omega$	217 Hz	1.8		−80		dB
			1 kHz			−77		
			20 kHz			−73		

CAPACITANCE (Typical values are for $T_A = 25°C$ unless otherwise specified.)

Symbol	Parameter	Condition	V_{CC} (V)	$T_A = -40°C$ to $+85°C$			Unit
				Min	Typ	Max	
C_{ON}	On Capacitance	$V_{SW} = 400$ mV_{PP}, f = 1 MHz,	0		21		pF
C_{OFF}	Off Capacitance	$V_{SW} = 400$ mV_{PP}, f = 1 Mhz, #1S = #2S = V_{CC}	1.8		25		pF
C_{CTRL}	Select Pin Capacitance	#nS = 400 mV_{PP}, f = 1 MHz	1.8		5		pF

TIMING DIAGRAMS
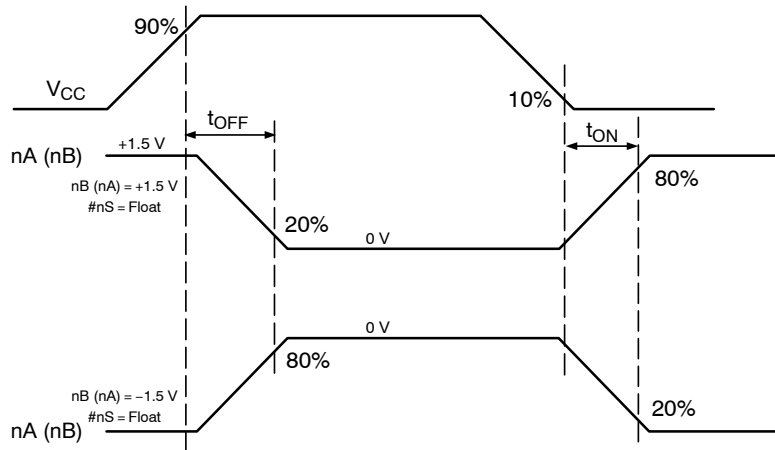
Figure 4. t_{ON}/t_{OFF} V_{CC} to Output Timing
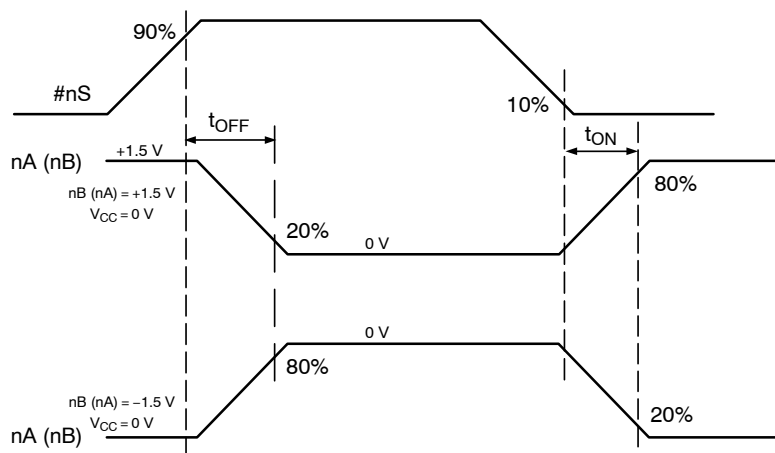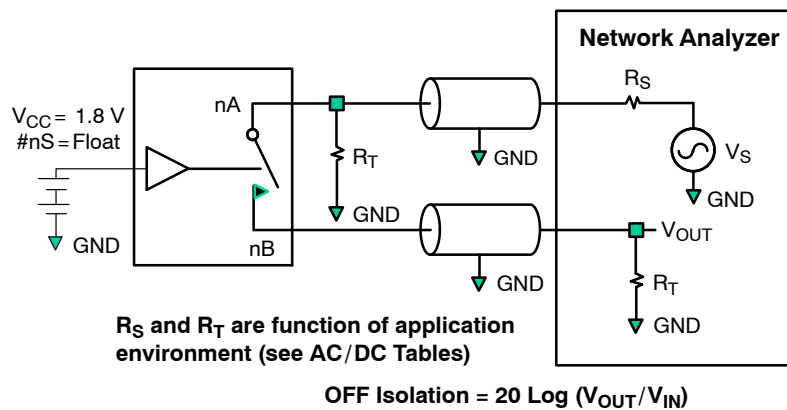

Figure 5. t_{ON}/t_{OFF} Select (#nS) to Output Timing

R_S and R_T are function of application environment (see AC/DC Tables)

OFF Isolation = 20 Log (V_{OUT}/V_{IN})

Figure 6. OFF Isolation

PRODUCT–SPECIFIC DIMENSIONS

E	D	X	Y
1.215±0.03 mm	1.385±0.03 mm	0.2075	0.2925

WLCSP9 1.385x1.215x0.581
CASE 567SV
ISSUE O

DATE 30 NOV 2016

0.03 C
2X

E → A

△E

BALL A1
INDEX AREA

B

D

0.03 C

TOP VIEW   2X

0.40

A1

0.40

(Ø0.215)
Cu Pad (Bottom)

(Ø0.315)
Solder Mask

RECOMMENDED LAND PATTERN
(NSMD PAD TYPE)

// 0.06 C

0.581±0.038

0.05 C

C

△D

SEATING
PLANE

SIDE VIEWS

0.378±0.018

0.203±0.020

⊕ 0.005(M) C A B

0.40

Ø0.260±0.02
9X

0.40

C
B
A

(Y) ±0.018

1 2 3

(X) ±0.018   △E

BOTTOM VIEW
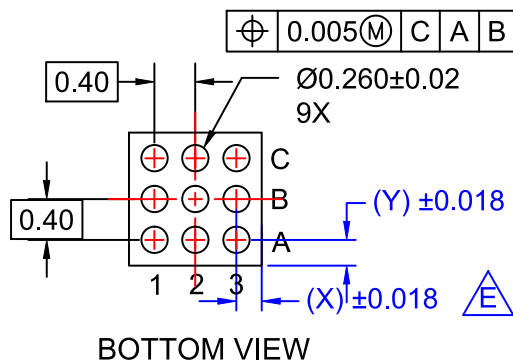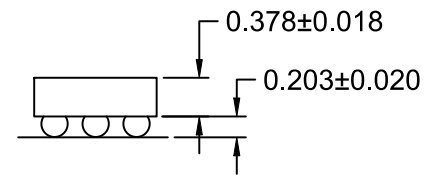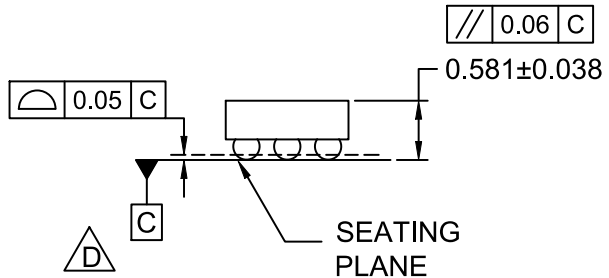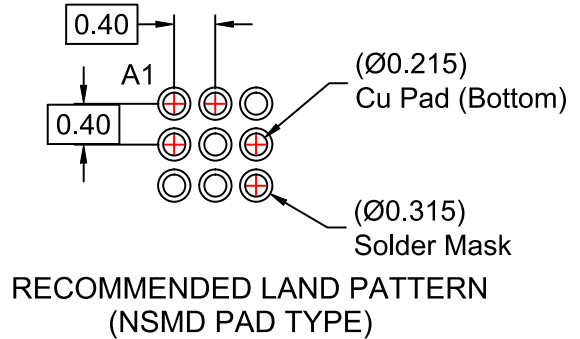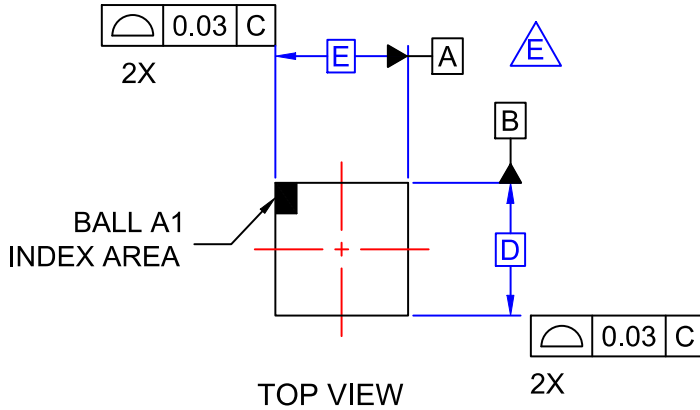
NOTES
A. NO JEDEC REGISTRATION APPLIES.
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS AND TOLERANCE   PER
    ASME Y14.5M, 2009.
D. DATUM C IS DEFINED BY THE
    SPHERICAL CROWNS OF THE BALLS.
E. FOR DIMENSIONS D,E,X, AND Y SEE
    PRODUCT DATASHEET.

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